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JAN 2 - 2007

Examining Group Number 2813

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Xiang Dai et al.

Examiner: James M. Mitchell

Serial No.: 10/612,663

Group Art Unit: 2813

Filed: July 2, 2003

Docket No.: 200308566-1

Title: SUPPORTING A CIRCUIT PACKAGE INCLUDING A SUBSTRATE
HAVING A SOLDER COLUMN ARRAY**AMENDMENT AND RESPONSE UNDER 37 C.F.R. 1.116**

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Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

This Amendment and Response is in reply to the Final Office Action mailed October 31, 2006. Please amend the above-identified patent application as follows: